74LVXC4245

OCTAL DUAL SUPPLY BUS TRANSCEIVER

- HIGH SPEED:
  t_{PD} = 6.5ns (MAX.) at
  V_{CCA} = 5.0V, V_{CCB} = 5.0V
- LOW POWER DISSIPATION:
  I_{CCA} = I_{CCB} = 5µA(MAX.) at T_A=25°C
- LOW NOISE: V_{OLP} =0.3V (TYP.) at
  V_{CCA}=5.0V V_{CCB} =3.3V
- SYMMETRICAL OUTPUT IMPEDANCE:
  $|I_{OH}| = I_{OL}$ = 24mA (MIN)
- BALANCED PROPAGATION DELAYS:
  $t_{PLH} \cong t_{PHL}$
- OPERATING VOLTAGE RANGE:
  V_{CCA}(OPR) = 4.5V to 5.5V (1.2V Data Retention)
  V_{CCB}(OPR) = 2.7V to 5.5V (1.2V Data Retention)
  PIN AND FUNCTION COMPATIBLE WITH
  74 SERIES C4245
- IMPROVED LATCH-UP IMMUNITY



SOP TSSOP

Table 1: Order Codes

PACKAGE	T & R
SOP	74LVXC4245MTR
TSSOP	74LVXC4245TTR

DESCRIPTION

The 74LVXC4245 is a dual supply 8 bit configurable low voltage CMOS OCTAL BUS TRANSCEIVER fabricated with sub-micron silicon gate and double-layer metal wiring C^2MOS technology. Designed for use as an interface between a 5V bus and a 3.3V to 5V bus in a mixed 5V/3.3V supply systems, it achieves high speed operation while maintaining the CMOS low power dissipation.

This IC is intended for two-way asynchronous communication between data buses and the direction of data transmission is determined by DIR input. The enable input $\overline{G}$ can be used to disable the device so that the buses are effectively isolated.

The A-port interfaces with the 5V bus, the B-port with the 3.3V to 5V bus.

All inputs are equipped with protection circuits against static discharge, giving them 2KV ESD immunity and transient excess voltage.

Figure 1: Pin Connection And IEC Logic Symbols

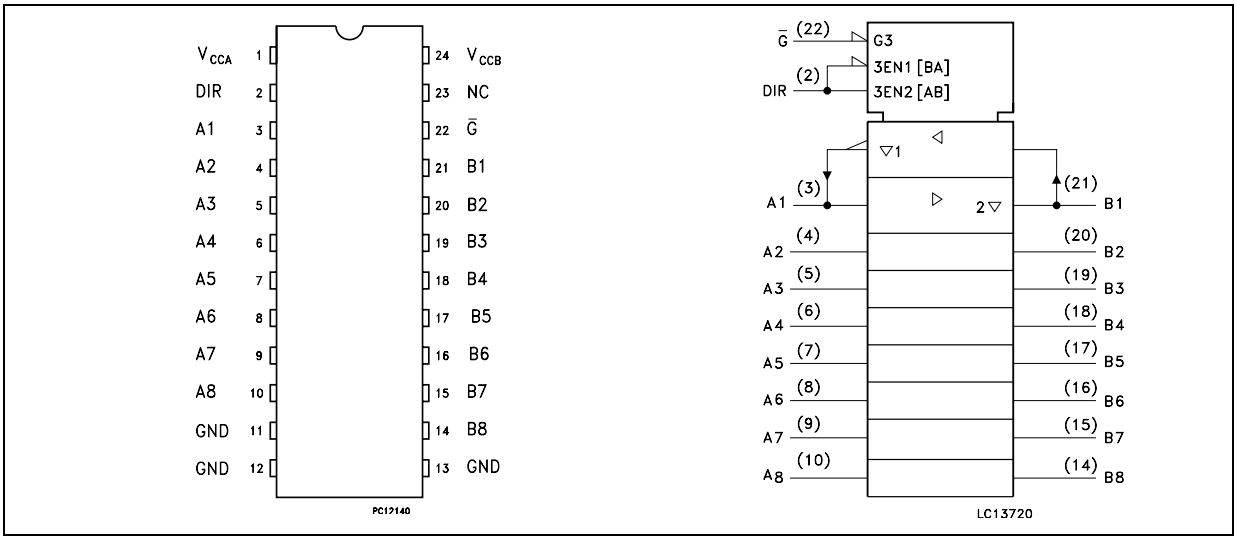


Figure 2: Input And Output Equivalent Circuit

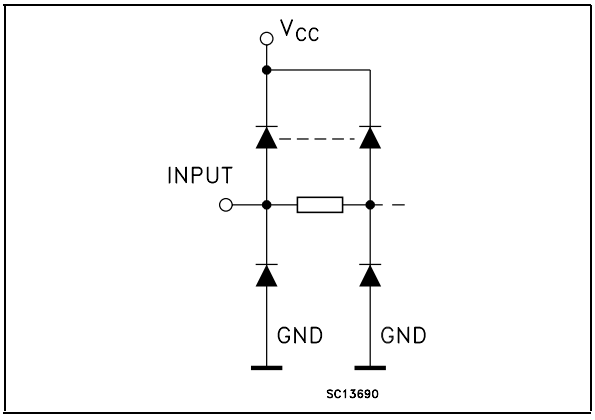


Table 2: Pin Description

PIN N°	SYMBOL	NAME AND FUNCTION
2	DIR	Directional Control
3, 4, 5, 6, 7, 8, 9, 10	A1 to A8	Data Inputs/Outputs
21, 20, 19, 18, 17, 16, 15, 14	B1 to B8	Data Inputs/Outputs
22	$\overline{G}$	Output Enable Input
11, 12, 13	GND	Ground (0V)
23	NC	Not Connected
1	V_{CCA}	Positive Supply Voltage
24	V_{CCB}	Positive Supply Voltage

Table 3: Truth Table

INPUTS		FUNCTION		OUTPUT
$\overline{G}$	DIR	A BUS	B BUS	
L	L	OUTPUT	INPUT	A = B
L	H	INPUT	OUTPUT	B = A
H	X	Z	Z	Z

X : Don't Care
Z : High Impedance

Table 4: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CCA}	Supply Voltage	-0.5 to +7.0	V
V_{CCB}	Supply Voltage	-0.5 to +7.0	V
V_I	DC Input Voltage	-0.5 to V_{CCA} + 0.5	V
$V_{I/OA}$	DC I/O Voltage	-0.5 to V_{CCA} + 0.5	V
$V_{I/OB}$	DC I/O Voltage	-0.5 to V_{CCB} + 0.5	V
I_{IK}	DC Input Diode Current	± 20	mA
I_{OK}	DC Output Diode Current	± 50	mA
I_{OA}	DC Output Current	± 50	mA
I_{OB}	DC Output Current	± 50	mA
I_{CCA}	DC V_{CC} or Ground Current	± 200	mA
I_{CCB}	DC V_{CC} or Ground Current	± 100	mA
P_d	Power Dissipation	180	mW
T_{stg}	Storage Temperature	-65 to +150	°C
T_L	Lead Temperature (10 sec)	300	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied

Table 5: Recommended Operating Conditions

Symbol	Parameter	Value	Unit
V_{CCA}	Supply Voltage (note 1)	4.5 to 5.5	V
V_{CCB}	Supply Voltage (note 1)	2.7 to 5.5	V
V_I	Input Voltage	0 to V_{CCA}	V
$V_{I/OA}$	I/O Voltage	0 to V_{CCA}	V
$V_{I/OB}$	I/O Voltage	0 to V_{CCB}	V
T_{op}	Operating Temperature	-40 to 85	°C
dt/dv	Input Rise and Fall Time (note 2)	0 to 10	ns/V

1) V_{IN} from 30% to 70% of V_{CC}
2) V_{CCA} = 4.5 to 5.5V; V_{CCB} = 2.7 to 3.6V;

Table 6: DC Specifications For V_{CCA}

Symbol	Parameter	Test Condition			Value							Unit
		V_{CCA} (V)	V_{CCB} (V)		T_A = 25 °C			-40 to 85 °C		-55 to 125°C		
					Min.	Typ.	Max.	Min.	Max.	Min.	Max.	
V_{IHA}	High Level Input Voltage	4.5	2.7		2.0			2.0		2.0		V
		4.5	3.6		2.0			2.0		2.0		
		5.5	5.5		2.0			2.0		2.0		
V_{ILA}	Low Level Input Voltage	4.5	2.7				0.8		0.8		0.8	V
		4.5	3.6				0.8		0.8		0.8	
		5.5	5.5				0.8		0.8		0.8	
V_{OHA}	High Level Output Voltage	4.5	3.0	I_O=-100 µA	4.4	4.5		4.4		4.4		V
		4.5	3.0	I_O=-24 mA	3.86			3.76		3.76		
V_{OLA}	Low Level Output Voltage	4.5	3.0	I_O=100 µA		0	0.1		0.1		0.1	V
		4.5	3.0	I_O=24 mA			0.36		0.44		0.44	
I_{IA}	Input Leakage Current	5.5	3.6	V_I = V_{CC} or GND			± 0.1		± 1		± 1	µA
I_{OZA}	High Impedance Output Leakage Current	5.5	3.6	V_{IA} = V_{IHA} or V_{ILA} V_{IB} = V_{IHB} or V_{ILB} $V_{I/OA}$ = V_{CCA} or GND			± 0.5		± 5		± 5	µA
I_{CCtA}	Quiescent Supply Current	5.5	3.6	V_{IA} = V_{CCA} or GND V_{IB} = V_{CCB} or GND			5		50		50	µA
I_{CCtAF}	Quiescent V_{CCA} Supply Current as B Port Floats	5.5	Open	V_{IA} = V_{CCA} or GND $\overline{G}$= DIR = V_{CCA} V_{IB} = Open			5		50		50	µA
ΔI_{CCtA}	Maximum Quiescent Supply Current / Input (An, DIR, $\overline{G}$)	5.5	5.5	V_{IA} = V_{CCA} - 2.1V V_{IB} = V_{CCB} or GND			1.35		1.5		1.5	mA

Table 7: DC Specifications For V_{CCB}

Symbol	Parameter	Test Condition			Value							Unit
		V_{CCA} (V)	V_{CCB} (V)		T_A = 25 °C			-40 to 85 °C		-55 to 125°C		
					Min.	Typ.	Max.	Min.	Max.	Min.	Max.	
V_{IHB}	High Level Input Voltage	4.5	2.7		2.0			2.0		2.0		V
		4.5	3.6		2.0			2.0		2.0		
		4.5	5.5		3.85			3.85		3.85		
V_{ILB}	Low Level Input Voltage	4.5	2.7				0.8		0.8		0.8	V
		4.5	3.6				0.8		0.8		0.8	
		4.5	5.5				1.65		1.65		1.65	
V_{OHB}	High Level Output Voltage	4.5	3.0	I_O=-100 µA	2.9	3.0		2.9		2.9		V
		4.5	3.0	I_O=-12 mA	2.56	2.85		2.46		2.46		
		4.5	3.0	I_O=-24 mA	2.35	2.65		2.25		2.25		
		4.5	2.7	I_O=-12 mA	2.3	2.5		2.2		2.2		
		4.5	2.7	I_O=-24 mA	2.1	2.3		2.0		2.0		
		4.5	4.5	I_O=-24 mA	3.86	4.25		3.76		3.76		
V_{OLB}	Low Level Output Voltage	4.5	3.0	I_O=100 µA		0.0	0.1		0.1		0.1	V
		4.5	3.0	I_O=24 mA		0.21	0.36		0.44		0.44	
		4.5	2.7	I_O=12 mA		0.11	0.36		0.44		0.44	
		4.5	2.7	I_O=24 mA		0.22	0.42		0.50		0.50	
		4.5	4.5	I_O=24 mA		0.18	0.36		0.44		0.44	
I_{IB}	Input Leakage Current	5.5	5.5	$V_I = V_{CCA}$ or GND			± 0.1		± 1		± 1	µA
I_{OZB}	High Impedance Output Leakage Current	5.5	5.5	$V_{IA} = V_{IHA}$ or V_{ILA} $V_{I/Ob} = V_{CCb}$ or GND			± 0.5		± 5		± 5	µA
I_{CCtB}	Quiescent Supply Current	5.5	5.5	$V_{IA} = V_{CCA}$ or GND $V_{IB} = V_{CCB}$ or GND			5		50		50	µA
ΔI_{CCtB}	Maximum Quiescent Supply Current / Input	5.5	3.6	$V_{IA} = V_{CCA}$ or GND $V_{IB} = V_{CCB}$ - 0.6V			0.35		0.5		0.5	mA

Table 8: Dynamic Switching Characteristics

Symbol	Parameter	Test Condition			Value							Unit
		V_{CCA} (V)	V_{CCB} (V)		T_A = 25 °C			-40 to 85 °C		-55 to 125°C		
					Min.	Typ.	Max.	Min.	Max.	Min.	Max.	
V_{OLPA}	Dynamic Low Level Quiet Output (note 1, 2)	5.0	3.3			1.0	1.5					V
		5.0	3.3		-1.2	-0.6						
V_{OLPB}	Dynamic Low Level Quiet Output (note 1, 2)	5.0	3.3			0.8	1.2					V
		5.0	3.3		-0.8	-0.5						
V_{IHDA}	Dynamic High Voltage Input (note 1, 3)	5.0	3.3				2					V
V_{ILDA}	Dynamic Low Voltage Input (note 1, 3)	5.0	3.3		0.8							V
V_{IHDB}	Dynamic High Voltage Input (note 1, 3)	5.0	3.3				2					V
V_{ILDB}	Dynamic Low Voltage Input (note 1, 3)	5.0	3.3		0.8							V

1) Worst case package
2) Max number of output defined as (n). Data inputs are driven 0V to 3.3V, (n-1) outputs switching and one output at GND
3) Max number of data inputs (n) switching. (n-1) switching 0V to 3.3V. Inputs under test switching: 3V to threshold (V_{ILD}). 0V to threshold (V_{IHD}) f = 1MHz

Table 9: AC Electrical Characteristics (C_L = 50pF, Input $t_r = t_f$ = 3ns)

Symbol	Parameter	Test Condition		Value (3)							Unit
		V_{CCB} (V)		T_A = 25°C			-40 to 85°C		-55 to 125°C		
				Min.	Typ.	Max.	Min.	Max.	Min.	Max.	
t_{PLH}	Propagation Delay Time (An to Bn)	2.7 to 3.6		1.0	5.5	7.5	1.0	8.0	1.0	8.5	ns
		5.0(*)		1.0	4.9	6.5	1.0	7.0	1.0	7.5	
t_{PHL}	Propagation Delay Time (An to Bn)	2.7 to 3.6		1.0	5.0	7.0	1.0	7.5	1.0	7.5	
		5.0(*)		1.0	4.0	5.5	1.0	6.0	1.0	6.5	
t_{PZL}	Output Enable Time ($\overline{G}$ to Bn)	2.7 to 3.6		1.0	6.7	9.0	1.0	10.0	1.0	10.5	ns
		5.0(*)		1.0	5.6	7.5	1.0	8.0	1.0	8.5	
t_{PZH}	Output Enable Time ($\overline{G}$ to Bn)	2.7 to 3.6		1.0	6.9	9.5	1.0	10.0	1.0	10.5	
		5.0(*)		1.0	5.7	7.5	1.0	8.0	1.0	8.5	
t_{PLZ}	Output Disable Time ($\overline{G}$ to Bn)	2.7 to 3.6		1.0	6.0	9.0	1.0	9.5	1.0	9.5	ns
		5.0(*)		1.0	4.8	7.0	1.0	7.5	1.0	7.5	
t_{PHZ}	Output Disable Time ($\overline{G}$ to Bn)	2.7 to 3.6		1.0	4.2	6.5	1.0	7.0	1.0	7.5	
		5.0(*)		1.0	3.8	5.5	1.0	6.0	1.0	6.5	
t_{PLH}	Propagation Delay Time (Bn to An)	2.7 to 3.6		1.0	5.6	7.5	1.0	8.0	1.0	8.5	ns
		5.0(*)		1.0	4.7	6.5	1.0	7.0	1.0	7.5	
t_{PHL}	Propagation Delay Time (Bn to An)	2.7 to 3.6		1.0	4.3	6.0	1.0	6.5	1.0	7.0	
		5.0(*)		1.0	3.9	5.0	1.0	5.5	1.0	5.5	
t_{PZL}	Output Enable Time ($\overline{G}$ to An)	2.7 to 3.6		1.0	8.0	10.0	1.0	11.0	1.0	11.5	ns
		5.0(*)		1.0	7.4	9.0	1.0	10.0	1.0	10.5	
t_{PZH}	Output Enable Time ($\overline{G}$ to An)	2.7 to 3.6		1.0	6.3	8.0	1.0	8.5	1.0	8.5	
		5.0(*)		1.0	6.1	7.5	1.0	8.5	1.0	8.5	
t_{PLZ}	Output Disable Time ($\overline{G}$ to An)	2.7 to 3.6		1.0	3.4	5.5	1.0	6.0	1.0	6.5	ns
		5.0(*)		1.0	3.4	5.5	1.0	6.0	1.0	6.5	
t_{PHZ}	Output Disable Time ($\overline{G}$ to An)	2.7 to 3.6		1.0	2.9	5.0	1.0	5.5	1.0	6.0	
		5.0(*)		1.0	2.9	4.5	1.0	5.0	1.0	5.5	
t_{OSLH} t_{OSHL}	Output To Output Skew Time (note1, 2)	2.7 to 3.6			0.5	1.0		1.5		1.5	ns
		5.0(*)			0.5	1.0		1.5		1.5	

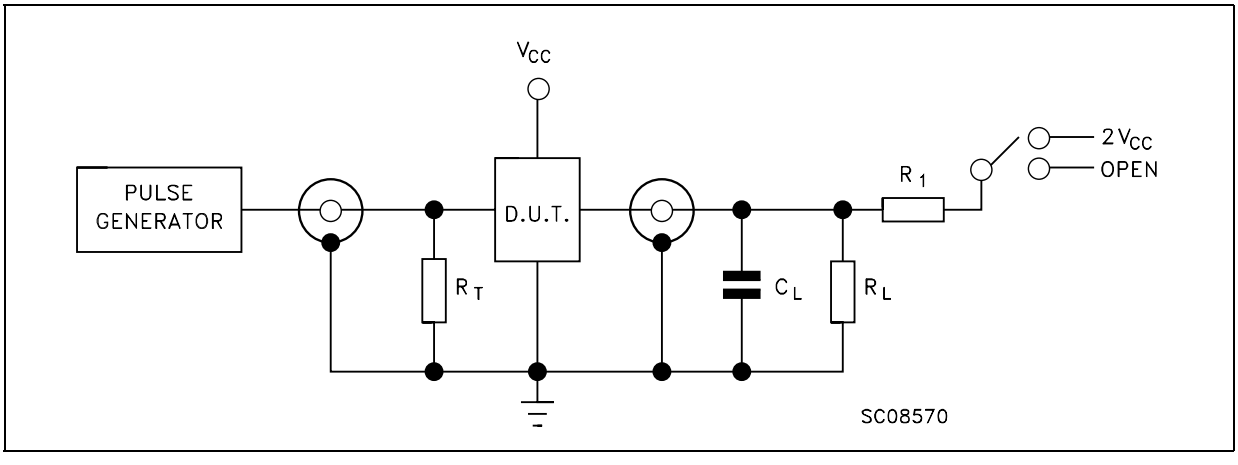
1) Skew is defined as the absolute value of the difference between the actual propagation delay for any two outputs of the same device switching in the same direction, either HIGH or LOW ($t_{OSLH} = |t_{PLHm} - t_{PLHn}|$, $t_{OSHL} = |t_{PHLm} - t_{PHLn}|$
2) Parameter guaranteed by design
3) Typical values referred at V_{CCA} = 5.0V, V_{CCB} = 5.0V or V_{CCA} = 5.0V, V_{CCB} = 3.3V
(*) Voltage Range is 5.0V ± 0.5

Table 10: Capacitive Characteristics

Symbol	Parameter	Test Condition			Value							Unit
		V_{CCA} (V)	V_{CCB} (V)		T_A = 25 °C			-40 to 85 °C		-55 to 125°C		
					Min.	Typ.	Max.	Min.	Max.	Min.	Max.	
C_{INA}	Input Capacitance	open	open			4.5	10		10		10	V
$C_{I/O}$	Input/Output Capacitance	5.0	3.3			10						V
C_{PD}	Dynamic Low Level Quiet Output (note 1) A to B	5.0	3.3			55						V
C_{PD}	Dynamic Low Level Quiet Output (note 1) B to A	5.0	3.3			40						V

1) C_{PD} is defined as the value of the IC's internal equivalent capacitance which is calculated from the operating current consumption without load. (Refer to Test Circuit). Average current can be obtained by the following equation. $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/8$ (per circuit)

Figure 3: Test Circuit



TEST	SWITCH
t_{PLH}, t_{PHL}	Open
t_{PZLH}, t_{PLZ}	$2V_{CC}$
t_{PZH}, t_{PHZ}	Open

C_L = 50pF or equivalent (includes jig and probe capacitance)
$R_L = R_1$ = 500Ω or equivalent
$R_T = Z_{OUT}$ of pulse generator (typically 50Ω)

Figure 4: Waveform - Propagation Delays (f=1MHz; 50% duty cycle)

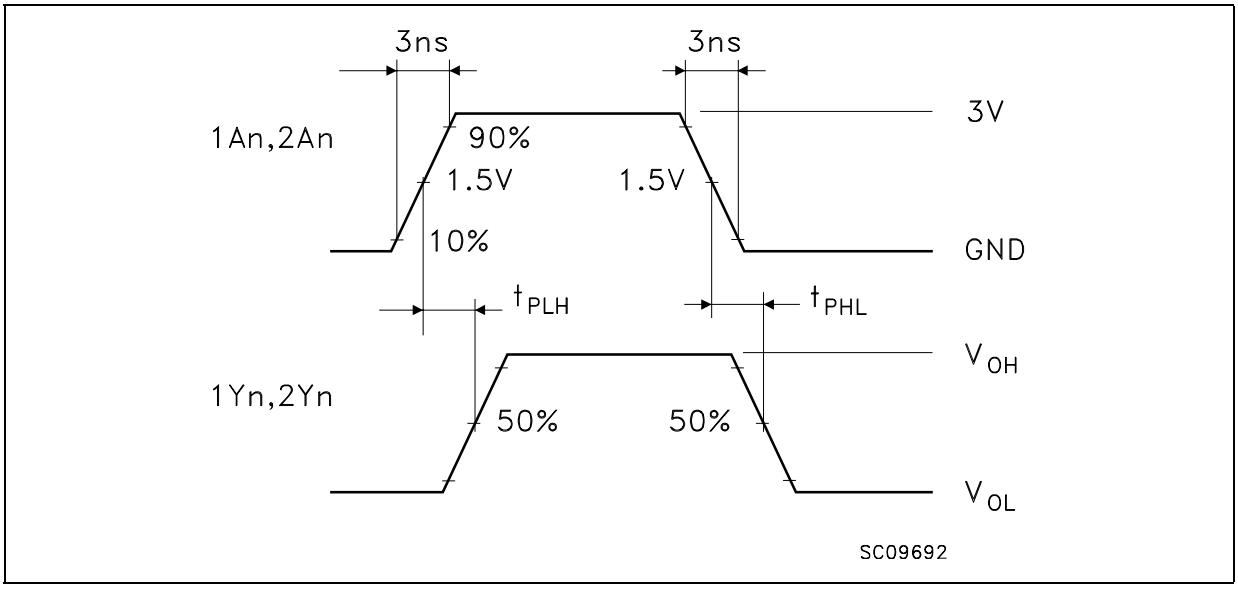
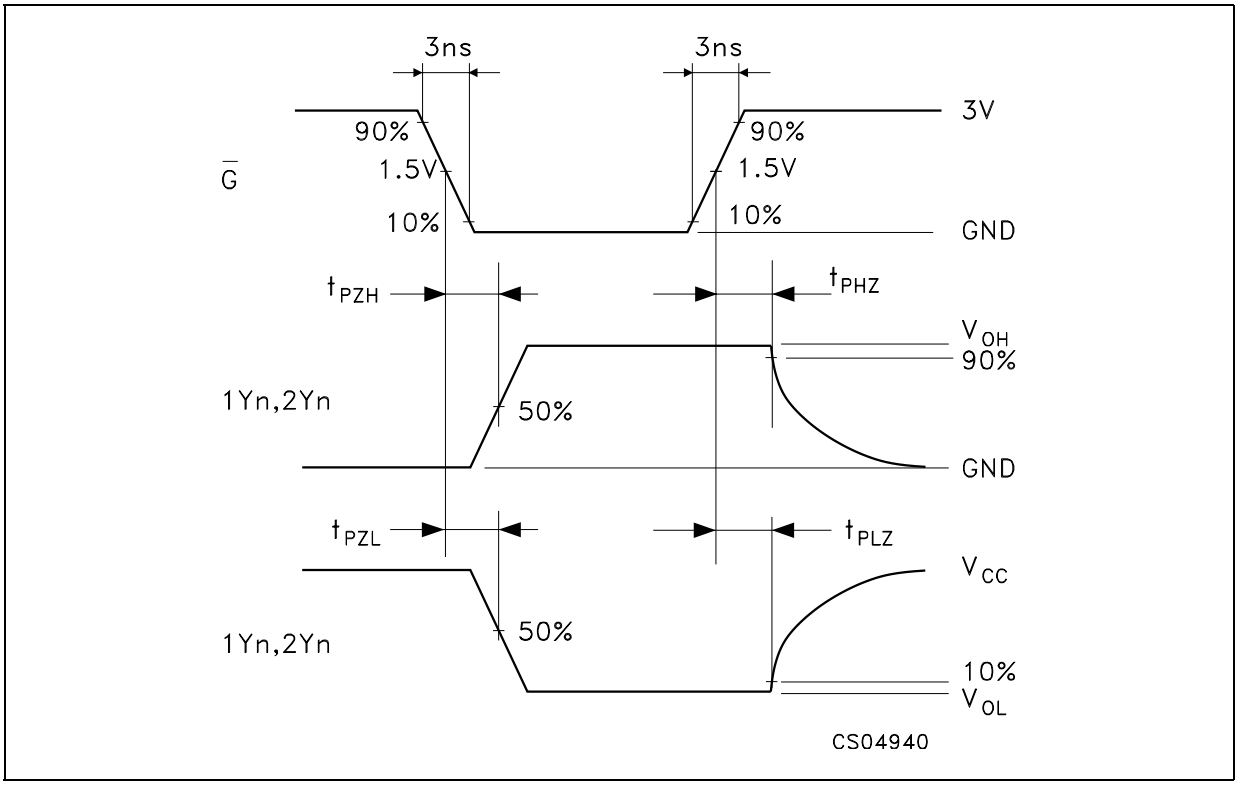
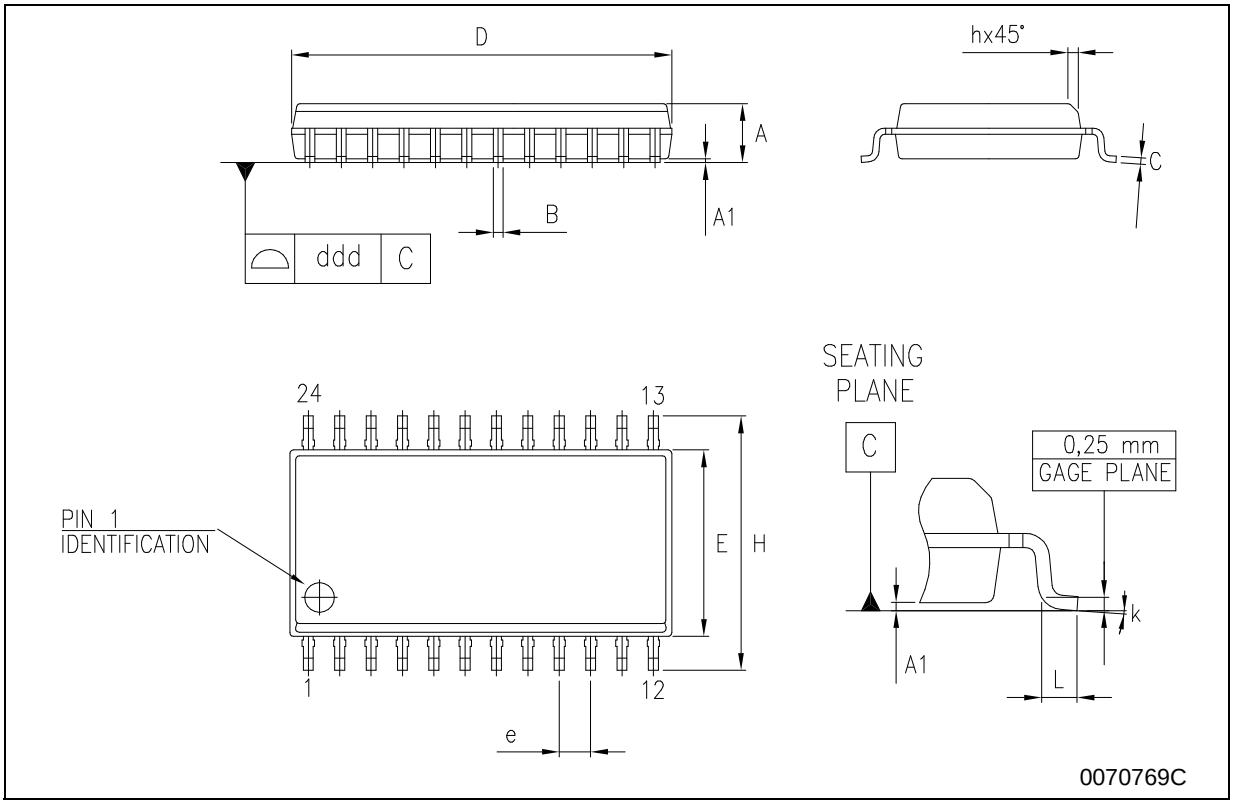


Figure 5: Waveform - Output Enable And Disable Time (f=1MHz; 50% duty cycle)



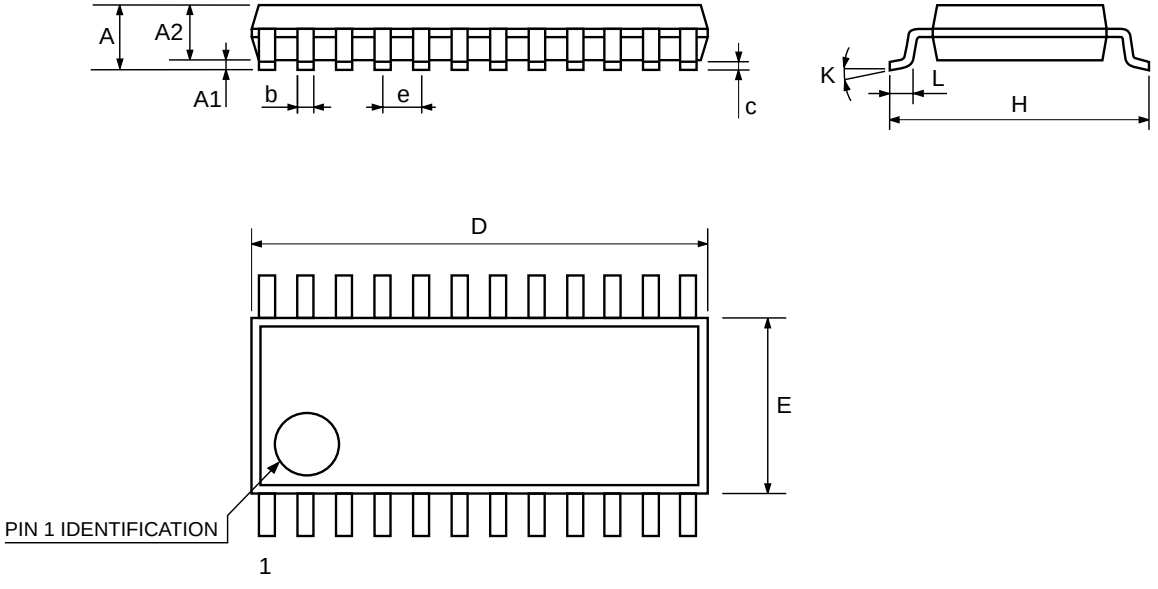
SO-24 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A	2.35		2.65	0.093		0.104
A1	0.1		0.30	0.004		0.012
B	0.33		0.51	0.013		0.020
C	0.23		0.32	0.009		0.013
D	15.20		15.60	0.598		0.614
E	7.4		7.6	0.291		0.299
e		1.27			0.050	
H	10.00		10.65	0.394		0.419
h	0.25		0.75	0.010		0.030
L	0.4		1.27	0.016		0.050
k	0°		8°	0°		8°
ddd			0.100			0.004



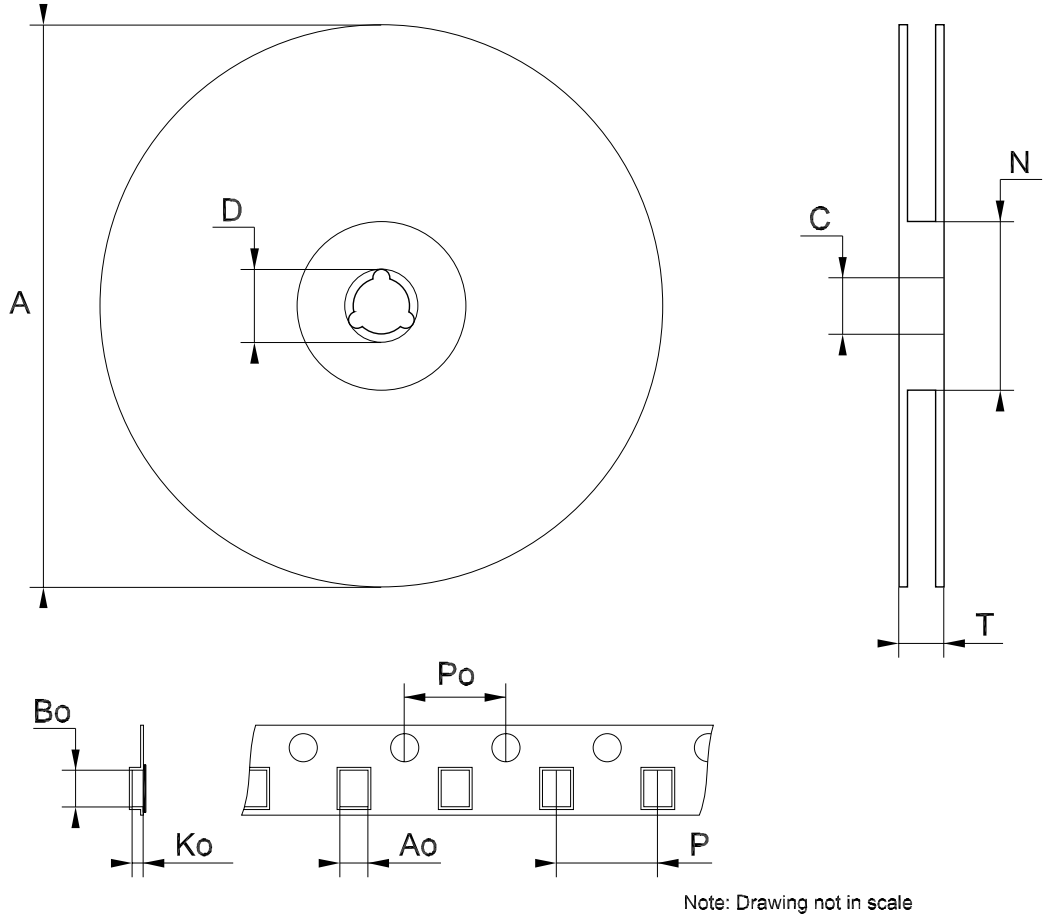
TSSOP24 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			1.1			0.043
A1	0.05		0.15	0.002		0.006
A2		0.9			0.035	
b	0.19		0.30	0.0075		0.0118
c	0.09		0.20	0.0035		0.0079
D	7.7		7.9	0.303		0.311
E	4.3		4.5	0.169		0.177
e		0.65 BSC			0.0256 BSC	
H	6.25		6.5	0.246		0.256
K	0°		8°	0°		8°
L	0.50		0.70	0.020		0.028



Tape & Reel SO-24 MECHANICAL DATA

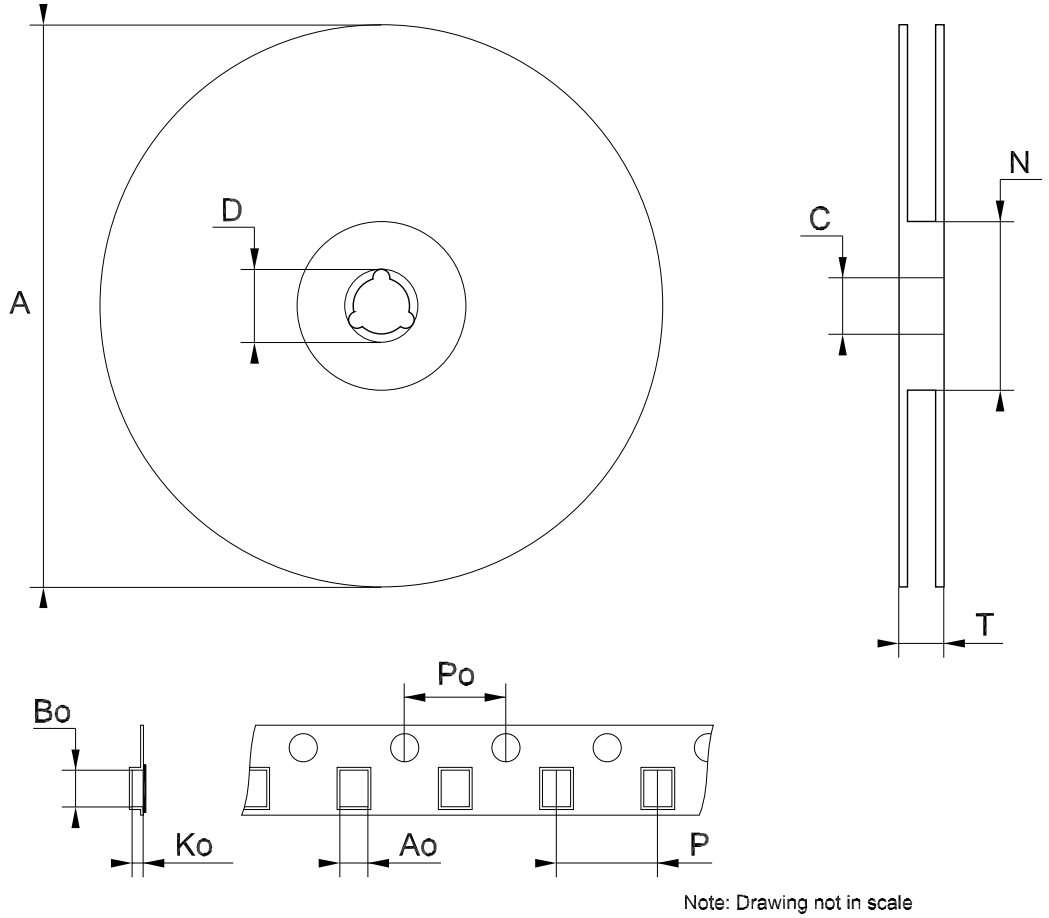
DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			330			12.992
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
T			30.4			1.197
Ao	10.8		11.0	0.425		0.433
Bo	15.7		15.9	0.618		0.626
Ko	2.9		3.1	0.114		0.122
Po	3.9		4.1	0.153		0.161
P	11.9		12.1	0.468		0.476



Note: Drawing not in scale

Tape & Reel TSSOP24 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			330			12.992
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
T			22.4			0.882
Ao	6.8		7	0.268		0.276
Bo	8.2		8.4	0.323		0.331
Ko	1.7		1.9	0.067		0.075
Po	3.9		4.1	0.153		0.161
P	11.9		12.1	0.468		0.476



Note: Drawing not in scale

Table 11: Revision History

Date	Revision	Description of Changes
27-Aug-2004	4	Ordering Codes Revision - pag. 1.

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Живое партнерство

ООО «ЛайфЭлектроникс» **“LifeElectronics” LLC**

ИНН 7805602321 КПП 780501001 Р/С 40702810122510004610 ФАКБ "АБСОЛЮТ БАНК" (ЗАО) в г.Санкт-Петербурге К/С 30101810900000000703 БИК 044030703

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- *Конкурентоспособные цены и скидки постоянным клиентам.*
- *Специальные условия для постоянных клиентов.*
- *Подбор аналогов.*
- *Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.*

- *Приемлемые сроки поставки, возможна ускоренная поставка.*
- *Доставку товара в любую точку России и стран СНГ.*
- *Комплексную поставку.*
- *Работу по проектам и поставку образцов.*
- *Формирование склада под заказчика.*

- *Сертификаты соответствия на поставляемую продукцию (по желанию клиента).*
- *Тестирование поставляемой продукции.*
- *Поставку компонентов, требующих военную и космическую приемку.*
- *Входной контроль качества.*
- *Наличие сертификата ISO.*

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- *Регистрацию проекта у производителя компонентов.*
- *Техническую поддержку проекта.*
- *Защиту от снятия компонента с производства.*
- *Оценку стоимости проекта по компонентам.*
- *Изготовление тестовой платы монтаж и пусконаладочные работы.*

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